

54AC10

54AC10 Triple 3-Input NAND Gate



Literature Number: SNOS080

54AC10 Triple 3-Input NAND Gate

General Description

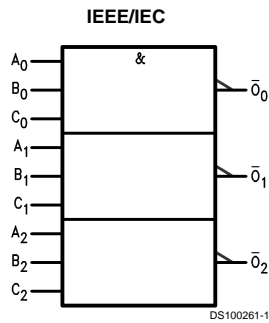
The 'AC10 contains three, 3-input NAND gates.

Features

- I_{CC} reduced by 50% on 54AC only

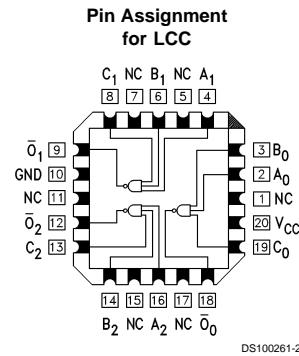
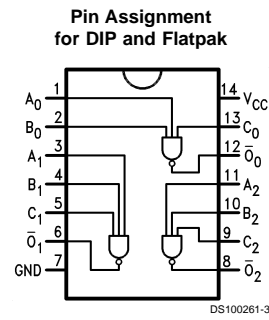
- Outputs source/sink 24 mA
- Standard Military Drawing (SMD)
— 'AC10: 5962-87610
- For Military 54ACT10 device see the 54ACTQ10

Logic Symbol



Pin Names	Description
A_n, B_n, C_n	Inputs
\bar{O}_n	Outputs

Connection Diagrams



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	-0.5V to +7.0V
DC Input Diode Current (I_{IK})	
$V_I = -0.5V$	-20 mA
$V_I = V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V_I)	-0.5V to $V_{CC} + 0.5V$
DC Output Diode Current (I_{OK})	
$V_O = -0.5V$	-20 mA
$V_O = V_{CC} + 0.5V$	+20 mA
DC Output Voltage (V_O)	-0.5V to $V_{CC} + 0.5V$
DC Output Source	
or Sink Current (I_O)	±50 mA
DC V_{CC} or Ground Current	
per Output Pin (I_{CC} or I_{GND})	±50 mA
Storage Temperature (T_{STG})	-65°C to +150°C

Junction Temperature (T_J)

CDIP

175°C

Recommended Operating Conditions

Supply Voltage (V_{CC})	'AC	2.0V to 6.0V
Input Voltage (V_I)		0V to V_{CC}
Output Voltage (V_O)		0V to V_{CC}
Operating Temperature (T_A)	54AC	-55°C to +125°C
Minimum Input Edge Rate ($\Delta V/\Delta t$)	'AC Devices	
	V_{IN} from 30% to 70% of V_{CC}	
	V_{CC} @ 3.3V, 4.5V, 5.5V	125 mV/ns

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of FACT™ circuits outside databook specifications.

DC Characteristics for 'AC Family Devices

Symbol	Parameter	V_{CC} (V)	54AC	Units	Conditions
			$T_A =$		
			-55°C to +125°C		
Guaranteed Limits					
V_{IH}	Minimum High Level Input Voltage	3.0	2.1	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
		4.5	3.15		
		5.5	3.85		
V_{IL}	Maximum Low Level Input Voltage	3.0	0.9	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
		4.5	1.35		
		5.5	1.65		
V_{OH}	Minimum High Level Output Voltage	3.0	2.9	V	$I_{OUT} = -50 \mu A$
		4.5	4.4		
		5.5	5.4		
V_{OL}	Maximum Low Level Output Voltage	3.0	2.4	V	(Note 2) $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -12 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -24 \text{ mA}$
		4.5	3.7		
		5.5	4.7		
V_{OL}	Maximum Low Level Output Voltage	3.0	0.1	V	$I_{OUT} = 50 \mu A$
		4.5	0.1		
		5.5	0.1		
V_{OL}	Maximum Low Level Output Voltage	3.0	0.5	V	(Note 2) $V_{IN} = V_{IL}$ or V_{IH} $I_{OL} = 12 \text{ mA}$ $I_{OL} = 24 \text{ mA}$ $I_{OL} = 24 \text{ mA}$
		4.5	0.5		
		5.5	0.5		
I_{IN}	Maximum Input Leakage Current	5.5	±1.0	µA	$V_I = V_{CC}, GND$
I_{OLD}	Minimum Dynamic	5.5	50	mA	$V_{OLD} = 1.65V \text{ Max}$
I_{OHD}	Output Current (Note 3)	5.5	-50	mA	$V_{OHD} = 3.85V \text{ Min}$
I_{CC}	Maximum Quiescent Supply Current	5.5	40.0	µA	$V_{IN} = V_{CC}$ or GND

Note 2: All outputs loaded; thresholds on input associated with output under test.

DC Characteristics for 'AC Family Devices (Continued)

Note 3: Maximum test duration 2.0 ms, one output loaded at a time.

Note 4: I_{IN} and I_{CC} @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V V_{CC} .
 I_{CC} for 54AC @ 25°C is identical to 74AC @ 25°C.

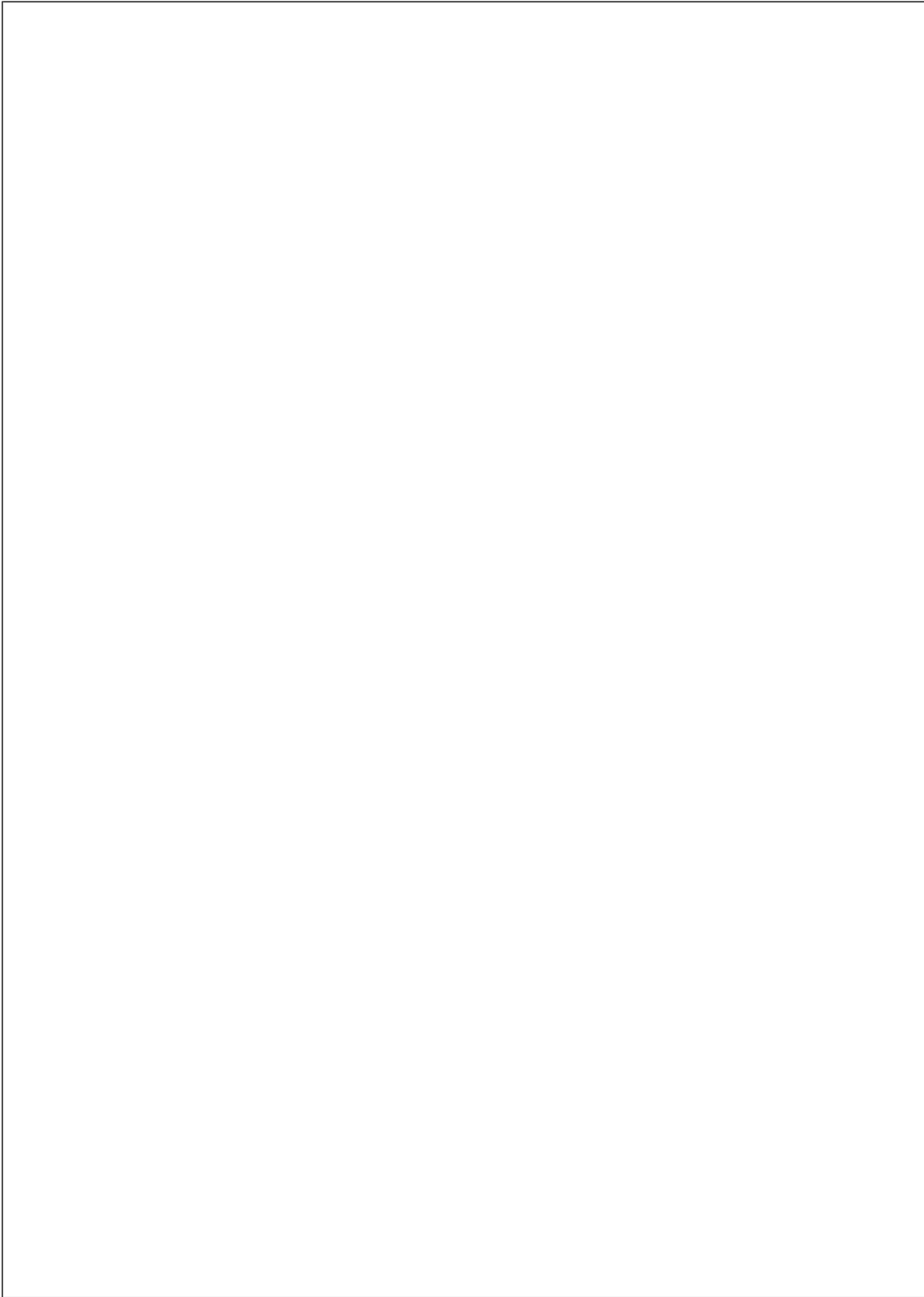
AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V) (Note 5)	54AC		Units	Fig. No.
			$T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$ $C_L = 50 \text{ pF}$			
			Min	Max		
t_{PLH}	Propagation Delay	3.3 5.0	1.0 1.5	11.0 8.5	ns	
t_{PHL}	Propagation Delay	3.3 5.0	1.0 1.5	10.0 7.0	ns	

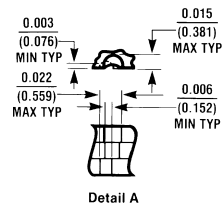
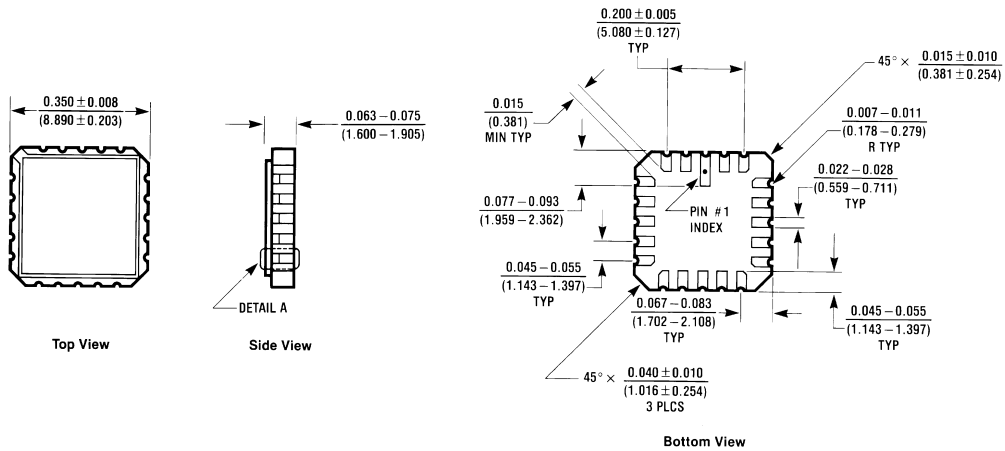
Note 5: Voltage Range 3.3 is 3.3V $\pm 0.3V$
Voltage Range 5.0 is 5.0V $\pm 0.5V$

Capacitance

Symbol	Parameter	Typ	Units	Conditions
C_{IN}	Input Capacitance	4.5	pF	$V_{CC} = \text{OPEN}$
C_{PD}	Power Dissipation Capacitance	25.0	pF	$V_{CC} = 5.0V$

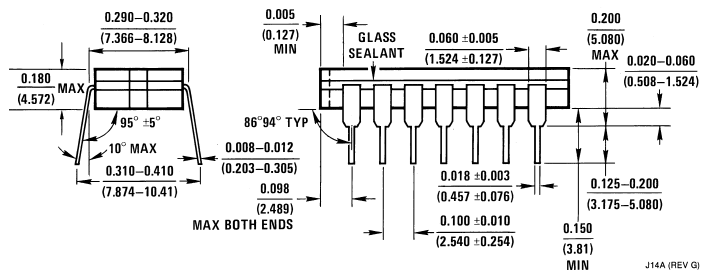
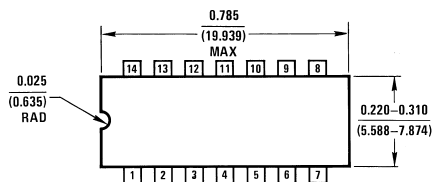


Physical Dimensions inches (millimeters) unless otherwise noted



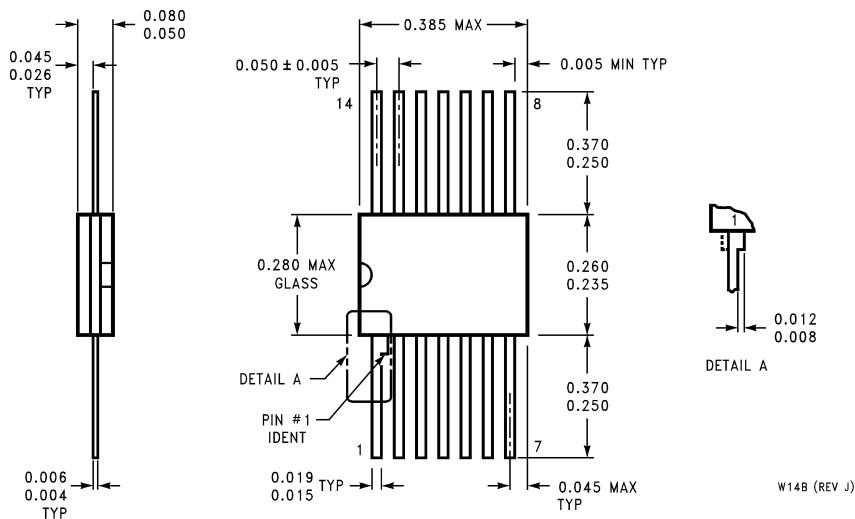
20 Terminal Ceramic Leadless Chip Carrier (L)
 NS Package Number E20A

E20A (REV D)



14 Lead Ceramic Dual-In-Line Package (D)
 NS Package Number J14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**14 Lead Ceramic Flatpak (F)
NS Package Number W14B**

W14B (REV J)

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